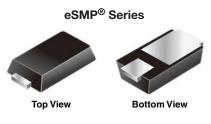
## VS-2EQH01-M3, VS-2EQH02-M3

**Vishay Semiconductors** 

## Ultrafast Rectifier, 2 A FRED Pt<sup>®</sup>



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### MicroSMP (DO-219AD)

Anode O Cathode

### LINKS TO ADDITIONAL RESOURCES



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PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	2 A			
V <sub>R</sub>	100 V, 200 V			
V <sub>F</sub> at I <sub>F</sub>	0.82 V			
t <sub>rr</sub> (typ.)	33 ns			
I <sub>FSM</sub>	30 A			
T <sub>J</sub> max.	175 °C			
Package	MicroSMP (DO-219AD)			
Circuit configuration	Single			

### **FEATURES**

- Very low profile typical height of 1.0 mm
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- · Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- For PFC, CRM snubber operation
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **TYPICAL APPLICATION**

For use in high frequency, freewheeling, DC/DC converters, PFC, and in snubber industrial and automotive applications.

### **MECHANICAL DATA**

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per J-STD-002, meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

ABSOLUTE MAXIMUM RATINGS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Peak repetitive reverse	VS-2EQH01-M3	V		100	V
voltage	VS-2EQH02-M3	V <sub>RRM</sub>		200	
Average rectified forward current		I <sub>F(AV)</sub>	T <sub>M</sub> = 137 °C	2	٨
Non-repetitive peak surge current		I <sub>FSM</sub>	T <sub>J</sub> = 25 °C, 10 ms sine pulse	30	A
Operating junction and st	torage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage,	VS-2EQH01-M3	V <sub>BR</sub> ,	L _ 100 ··· A	100	-	-	
blocking voltage	VS-2EQH02-M3	V <sub>R</sub>	I <sub>R</sub> = 100 μA	200			v
Forward welters	V <sub>F</sub>	I <sub>F</sub> = 2 A	-	0.96	1.05		
Forward voltage		I <sub>F</sub> = 2 A, T <sub>J</sub> = 150 °C	-	0.82	0.84		
	I <sub>R</sub>	$V_{R} = V_{R}$ rated	-	-	1		
Reverse leakage current		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	25	μA	
Junction capacitance		CT	V <sub>R</sub> = 200 V	-	6	-	pF

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COMPLIANT HALOGEN FREE



## VS-2EQH01-M3, VS-2EQH02-M3

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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 50$	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s}, V_R = 30 \text{ V}$		33	-	
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> = 0.25 A		-	-	23	
		T <sub>J</sub> = 25 °C	I <sub>F</sub> = 2 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 100 V	-	19	-	ns
		T <sub>J</sub> = 125 °C		-	33	-	
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	1.7	-	A
		T <sub>J</sub> = 125 °C		-	2.5	-	
Reverse recovery charge Q <sub>rr</sub>	0	T <sub>J</sub> = 25 °C		-	15	-	nC
	T <sub>J</sub> = 125 °C		-	34	-	no	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C
Thermal resistance, junction to mount	R <sub>thJM</sub> <sup>(1)</sup>		-	16	20	
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Device mounted on FR4 PCB, 2 oz. standard footprint	-	160	-	°C/W
Marking device VS-1EQH01-M3		Case style MicroSMP (DO-219AD)	2H1			
VS-2EQH02-M3		Case style MicroSivir (DO-219AD)		21	H2	

#### Note

<sup>(1)</sup> Thermal resistance junction to mount follows JEDEC<sup>®</sup> 51-14 transient dual interface test method (TDIM)

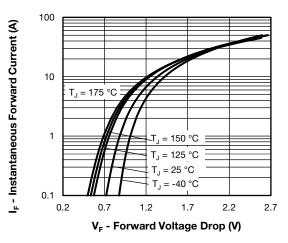


Fig. 1 - Typical Forward Voltage Drop Characteristics

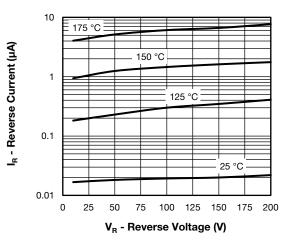
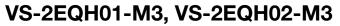


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



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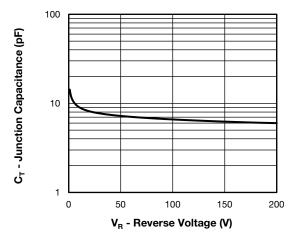


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

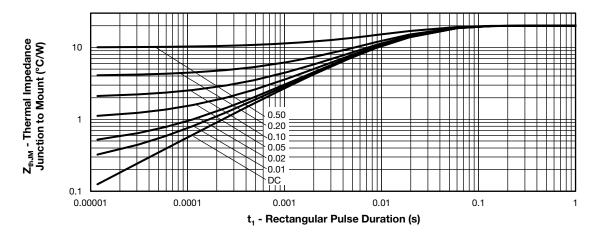


Fig. 4 - Maximum Transient Thermal Impedance, Junction to Mount

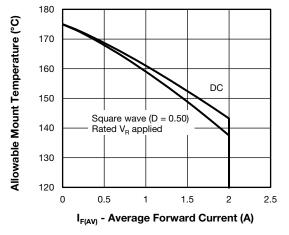
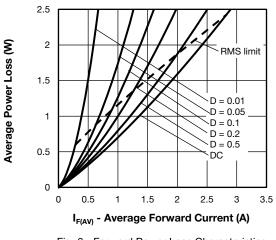
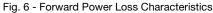


Fig. 5 - Maximum Allowable Mount Temperature vs. Average Forward Current





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#### Note

 $\begin{array}{l} \mbox{Formula used: } T_M = T_J \mbox{-} (Pd + Pd_{REV}) \ x \ R_{thJM}; \\ \mbox{Pd} = \mbox{forward power loss} = I_{F(AV)} \ x \ V_{FM} \ at \ (I_{F(AV)}/D) \ (see \ fig. \ 5); \\ \mbox{Pd}_{REV} = \ inverse \ power \ loss = V_{R1} \ x \ I_R \ (1 \ - D); \ I_R \ at \ V_{R1} = \ rated \ V_R \end{array}$ 

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## VS-2EQH01-M3, VS-2EQH02-M3

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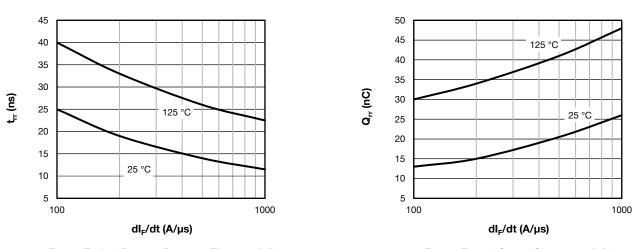


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

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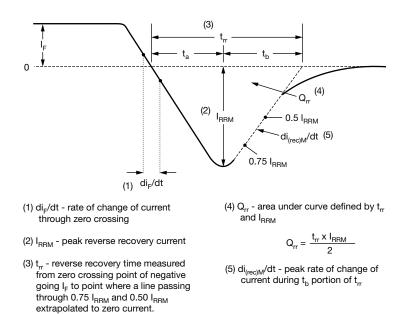
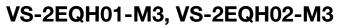


Fig. 9 - Reverse Recovery Waveform and Definitions

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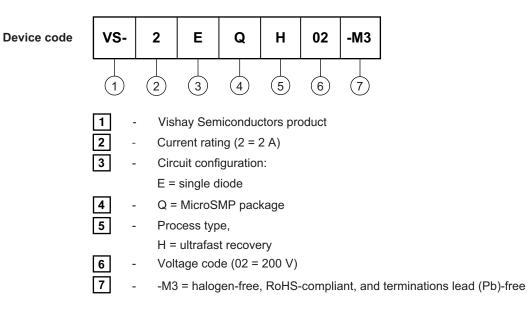


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### **ORDERING INFORMATION TABLE**

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ORDERING INFORMATION (Example)					
PREFERRED P/N	PREFERRED PACKAGE CODE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-2EQH01-M3/H	Н	4500	7" diameter plastic tape and reel		
VS-2EQH02-M3/H	Н	4500	7" diameter plastic tape and reel		

LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?96591				
Part marking information	www.vishay.com/doc?96590			
Packaging information	www.vishay.com/doc?88869			
SPICE model	www.vishay.com/doc?96595			

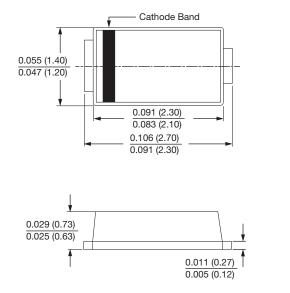


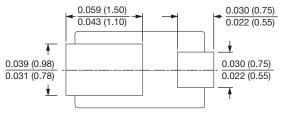
## **Outline Dimensions**

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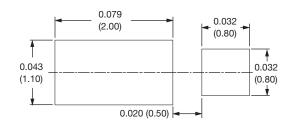
# MicroSMP (DO-219AD), FRED Pt<sup>®</sup>

### **DIMENSIONS** in inches (millimeters)





Mounting Pad Layout





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